

Title (en)

NOVEL MACROMOLECULAR COMPOUNDS HAVING A CORE-SHELL STRUCTURE FOR USE AS SEMICONDUCTORS

Title (de)

NEUE MAKROMOLEKULARE VERBINDUNGEN AUFWEISEND EINE KERN-SCHALE-STRUKTUR ZUR VERWENDUNG ALS HALBLEITER

Title (fr)

NOUVEAUX COMPOSÉS MACROMOLÉCULAIRES À STRUCTURE NOYAU-ENVELOPPE, EN VUE DE LEUR UTILISATION COMME SEMI-CONDUCTEURS

Publication

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Application

EP 09721087 A 20090210

Priority

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Abstract (en)

[origin: WO2009112319A1] The invention relates to novel macromolecular compounds having a core-shell structure and to the use thereof in electronic components.

IPC 8 full level

C08G 83/00 (2006.01); **C08G 61/00** (2006.01); **C08G 61/12** (2006.01); **C08G 77/00** (2006.01); **C09K 11/00** (2006.01); **H01B 1/00** (2006.01);
H01L 51/00 (2006.01); **H05B 33/00** (2006.01)

CPC (source: EP US)

C08G 61/10 (2013.01 - EP US); **C08G 61/126** (2013.01 - EP US); **C08G 83/00** (2013.01 - EP US); **C08G 83/002** (2013.01 - EP US);
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